1. General description

The 74LVCU04A is a general purpose hex inverter. Each of the six inverters is a single stage with unbuffered outputs.

2. Features and benefits

- Wide supply voltage range from 1.2 V to 3.6 V
- Inputs accept voltages up to 5.5 V
- CMOS low power consumption
- Direct interface with TTL levels
- Complies with JEDEC standard:
 - ◆ JESD8-7A (1.65 V to 1.95 V)
 - ◆ JESD8-5A (2.3 V to 2.7 V)
 - ◆ JESD8-C/JESD36 (2.7 V to 3.6 V)
- ESD protection:
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-B exceeds 200 V
 - CDM JESD22-C101E exceeds 1000 V
- Specified from –40 °C to +85 °C and –40 °C to +125 °C

3. Ordering information

Table 1.	Ordering	information
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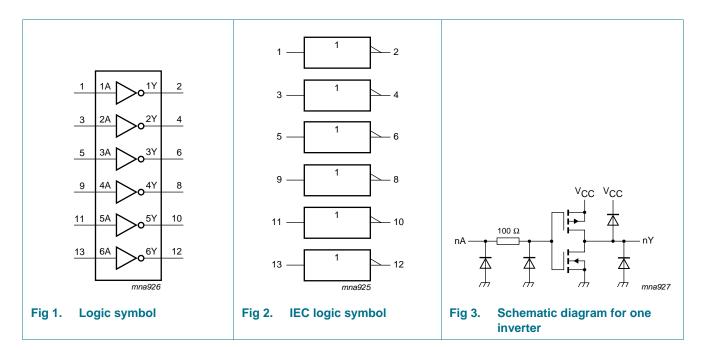
Type number	Package						
	Temperature range Name		Description	Version			
74LVCU04AD	–40 °C to +125 °C	SO14	plastic small outline package; 14 leads; body width 3.9 mm	SOT108-1			
74LVCU04ADB	–40 °C to +125 °C	SSOP14	plastic shrink small outline package; 14 leads; body width 5.3 mm	SOT337-1			
74LVCU04APW	–40 °C to +125 °C	TSSOP14	plastic thin shrink small outline package; 14 leads; body width 4.4 mm	SOT402-1			
74LVCU04ABQ	–40 °C to +125 °C	DHVQFN14	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body $2.5 \times 3 \times 0.85$ mm	SOT762-1			





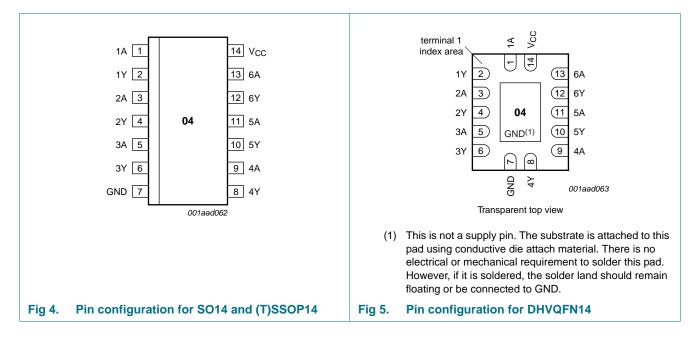
Hex inverter

4. Functional diagram



5. Pinning information

5.1 Pinning





5.2 Pin description

Table 2. Pin descrip	tion	
Symbol	Pin	Description
1A, 2A, 3A, 4A, 5A, 6A	1, 3, 5, 9, 11, 13	data input
1Y, 2Y, 3Y, 4Y, 5Y, 6Y	2, 4, 6, 8, 10, 12	data output
GND	7	ground (0 V)
V _{CC}	14	supply voltage

6. Functional description

Table 3.	Function table ^[1]	
Input nA		Output nY
L	I	Н
Н		L

[1] H = HIGH voltage level; L = LOW voltage level

Limiting values 7.

Limiting values Table 4.

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+6.5	V
I _{IK}	input clamping current	V ₁ < 0 V	-50	-	mA
VI	input voltage		<u>[1]</u> –0.5	+6.5	V
I _{OK}	output clamping current	$V_{\rm O}$ > $V_{\rm CC}$ or $V_{\rm O}$ < 0 V	-	±50	mA
Vo	output voltage		[2] -0.5	V _{CC} + 0.5	V
lo	output current	$V_{O} = 0 V$ to V_{CC}	-	±50	mA
I _{CC}	supply current		-	100	mA
I _{GND}	ground current		-100	-	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 \ ^{\circ}C \ to \ +125 \ ^{\circ}C$	<u>[3]</u>	500	mW

[1] The minimum input voltage ratings may be exceeded if the input current ratings are observed.

[2] The output voltage ratings may be exceeded if the output current ratings are observed.

[3] For SO14 packages: above 70 °C the value of P_{tot} derates linearly with 8 mW/K. For (T)SSOP14 packages: above 60 °C the value of P_{tot} derates linearly with 5.5 mW/K. For DHVQFN14 packages: above 60 °C the value of Ptot derates linearly with 4.5 mW/K.

Hex inverter

8. Recommended operating conditions

Table 5.	Recommended operating conditions						
Symbol	Parameter	Conditions	Min	Тур	Max	Unit	
V _{CC}	supply voltage		1.65	-	3.6	V	
		functional	1.2	-	-	V	
VI	input voltage		0	-	5.5	V	
Vo	output voltage		0	-	V _{CC}	V	
T _{amb}	ambient temperature	in free air	-40	-	+125	°C	
$\Delta t / \Delta V$	input transition rise and fall rate	V_{CC} = 1.65 V to 2.7 V	0	-	20	ns/V	
		V _{CC} = 2.7 V to 3.6 V	0	-	10	ns/V	

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40	°C to +85	S°C	–40 °C to	–40 °C to +125 °C		
			Min	Typ[1]	Max	Min	Max	_	
V _{IH}	HIGH-level	$V_{OL(max)} = 0.5 \text{ V}; I_O = -100 \mu\text{A}$				1		l	
	input voltage	V _{CC} = 1.2 V	1.08	-	-	1.12	-	V	
		V_{CC} = 1.65 V to 1.95 V	1.3	-	-	1.5	-	V	
		V_{CC} = 2.3 V to 2.7 V	1.8	-	-	2.0	-	V	
		$V_{CC} = 3.0 V$	2.0	-	-	2.4	-	V	
		$V_{CC} = 3.6 V$	2.4	-	-	2.8	-	V	
V _{IL}	LOW-level input voltage	$\label{eq:VOH(min)} \begin{split} V_{OH(min)} &= V_{CC} - 0.5 \ V; \\ I_O &= -100 \ \mu A \end{split}$							
		V _{CC} = 1.2 V	-	-	0.12	-	0.1	V	
		V _{CC} = 1.65 V to 1.95 V	-	-	0.6	-	0.4	V	
		V_{CC} = 2.3 V to 2.7 V	-	-	0.6	-	0.5	V	
		$V_{CC} = 3.0 V$	-	-	1.0	-	0.6	V	
		$V_{CC} = 3.6 V$	-	-	1.2	-	0.7	V	
V _{OH}	HIGH-level	V _I = GND							
	output	V_{CC} = 3.0 V; I_{O} = -100 μ A	$V_{CC}-0.2$	-	-	$V_{CC}-0.3$	-	V	
	voltage	V_{CC} = 1.65 V; I _O = -4 mA	1.2	-	-	1.05	-	V	
		$V_{CC} = 2.3 \text{ V}; I_{O} = -8 \text{ mA}$	1.8	-	-	1.65	-	V	
		V_{CC} = 2.7 V; I _O = -12 mA	2.2	-	-	2.05	-	V	
		V_{CC} = 3.0 V; I _O = -18 mA	2.4	-	-	2.25	-	V	
		V_{CC} = 3.0 V; I_{O} = –24 mA	2.2	-	-	2.0	-	V	

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		<u> </u>		.0	,			
Symbol Parameter		Conditions	-40	°C to +85	5 °C	–40 °C to	• +125 °C	Unit
			Min	Typ <mark>[1]</mark>	Мах	Min	Max	
V _{OL}	LOW-level	$V_I = V_{CC}$						
	output voltage	$V_{CC} = 3.0 \text{ V}; I_{O} = 100 \ \mu\text{A}$	-	-	0.20	-	0.60	V
	vollage	$V_{CC} = 1.65 \text{ V}; I_{O} = 4 \text{ mA}$	-	-	0.45	-	0.65	V
		$V_{CC} = 2.3 \text{ V}; I_{O} = 8 \text{ mA}$	-	-	0.60	-	0.80	V
		$V_{CC} = 2.7 \text{ V}; I_{O} = 12 \text{ mA}$	-	-	0.40	-	0.30	V
		$V_{CC} = 3.0 \text{ V}; I_{O} = 24 \text{ mA}$	-	-	0.55	-	0.80	V
I _I	input leakage current	V_{CC} = 3.6 V; $V_{\rm I}$ = 5.5 V or GND	-	±0.1	±5	-	±20	μΑ
I _{CC}	supply current	V_{CC} = 3.6 V; V_{I} = V_{CC} or GND; I_{O} = 0 A	-	0.1	10	-	40	μΑ
ΔI_{CC}	additional supply current	per input pin; $V_{CC} = 2.7 V \text{ to } 3.6 V;$ $V_I = V_{CC} - 0.6 V; I_O = 0 A$	-	5	500	-	5000	μΑ
Cı	input capacitance	$V_{CC} = 0 V \text{ to } 3.6 V;$ $V_I = GND \text{ to } V_{CC}$	-	5.5	-	-	-	pF

Table 6. Static characteristics ...continued

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

[1] All typical values are measured at V_{CC} = 3.3 V (unless stated otherwise) and T_{amb} = 25 °C.

10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 9.

Symbol	Parameter	Conditions	Conditions		–40 °C to +85 °C			o +125 ℃	Unit
				Min	Typ <mark>[1]</mark>	Max	Min	Max	
t _{pd}	propagation delay	nA to nY; see Figure 6	[2]						
		V _{CC} = 1.2 V		-	6.0	-	-	-	ns
		V_{CC} = 1.65 V to 1.95 V		0.3	3.7	7.8	0.3	9.0	ns
		V_{CC} = 2.3 V to 2.7 V		0.5	2.2	4.4	0.5	5.2	ns
		$V_{CC} = 2.7 V$		0.5	2.0	4.5	0.5	6.0	ns
		V_{CC} = 3.0 V to 3.6 V		0.5	2.0	4.0	0.5	5.0	ns
t _{sk(o)}	output skew time	V_{CC} = 3.0 V to 3.6 V	<u>[3]</u>	-	-	1.0	-	1.5	ns
C _{PD}	power dissipation	per inverter; $V_I = GND$ to V_{CC}	[4]						
	capacitance	V_{CC} = 1.65 V to 1.95 V		-	2.3	-	-	-	pF
		V_{CC} = 2.3 V to 2.7 V		-	5.5	-	-	-	pF
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		-	8.4	-	-	-	pF

[1] Typical values are measured at T_{amb} = 25 °C and V_{CC} = 1.2 V, 1.8 V, 2.5 V, 2.7 V, and 3.3 V respectively.

[2] t_{pd} is the same as t_{PLH} and t_{PHL} .

[3] Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.

[4] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

 $\mathsf{P}_{\mathsf{D}} = \mathsf{C}_{\mathsf{P}\mathsf{D}} \times \mathsf{V}_{\mathsf{C}\mathsf{C}}^2 \times \mathsf{f}_i \times \mathsf{N} + \Sigma(\mathsf{C}_{\mathsf{L}} \times \mathsf{V}_{\mathsf{C}\mathsf{C}}^2 \times \mathsf{f}_o) \text{ where:}$

 f_i = input frequency in MHz; f_o = output frequency in MHz

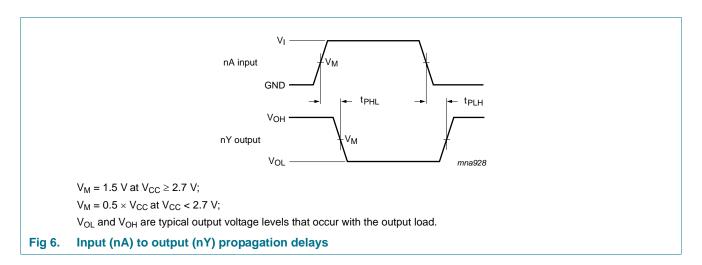
 C_L = output load capacitance in pF

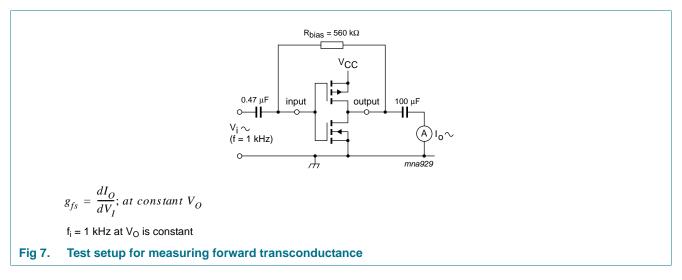
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 V_{CC} = supply voltage in Volts N = number of inputs switching

 $\Sigma(C_L \times V_{CC}^2 \times f_o)$ = sum of the outputs

11. Waveforms

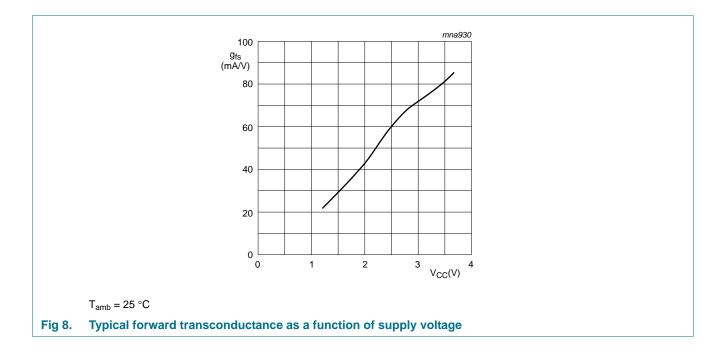




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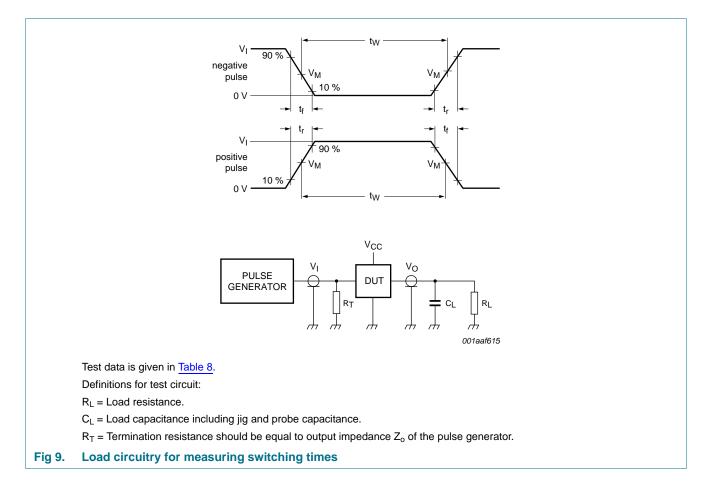


Table 8. Test data

Supply voltage	Input	Input		
	VI	t _r , t _f	CL	RL
1.2 V	V _{CC}	\leq 2 ns	30 pF	1 kΩ
1.65 V to 1.95 V	V _{CC}	\leq 2 ns	30 pF	1 kΩ
2.3 V to 2.7 V	V _{CC}	\leq 2 ns	30 pF	500 Ω
2.7 V	2.7 V	\leq 2.5 ns	50 pF	500 Ω
3.0 V to 3.6 V	2.7 V	\leq 2.5 ns	50 pF	500 Ω



12. Application information

12.1 Application diagrams

Some applications for the 74LVCU04 are:

- Linear amplifier: see Figure 10
- Crystal oscillator designs; see Figure 11
- Astable multivibrator; see Figure 12

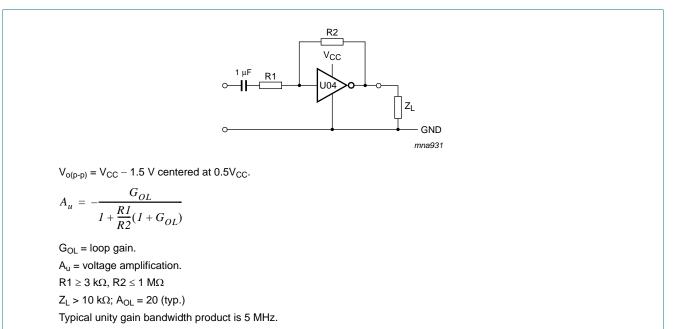
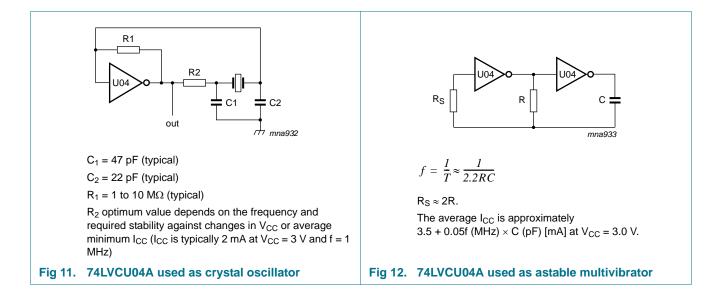


Fig 10. 74LVCU04A used as linear amplifier



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13. Package outline

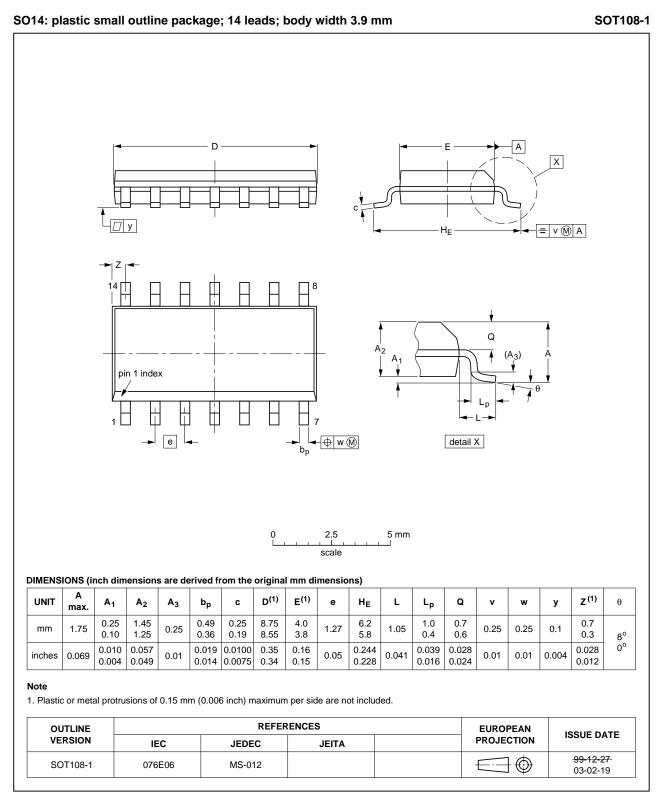


Fig 13. Package outline SOT108-1 (SO14)

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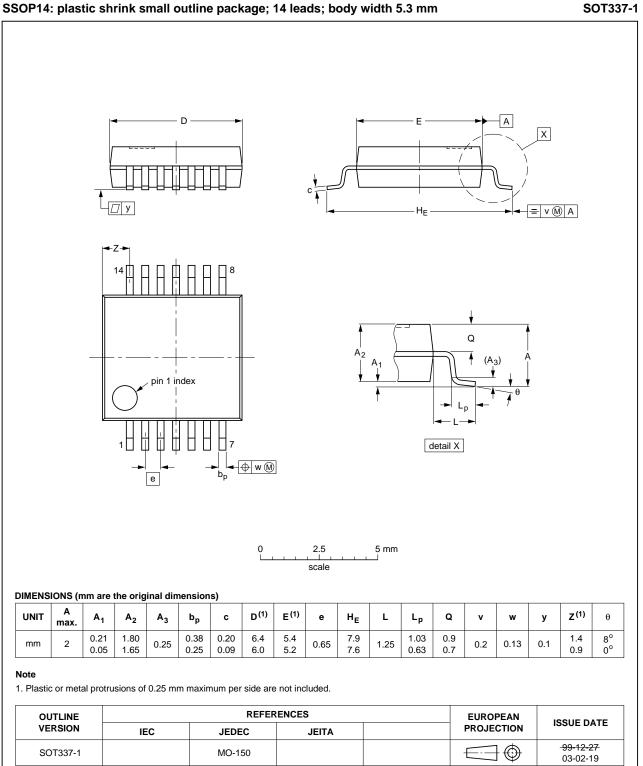


Fig 14. Package outline SOT337-1 (SSOP14)

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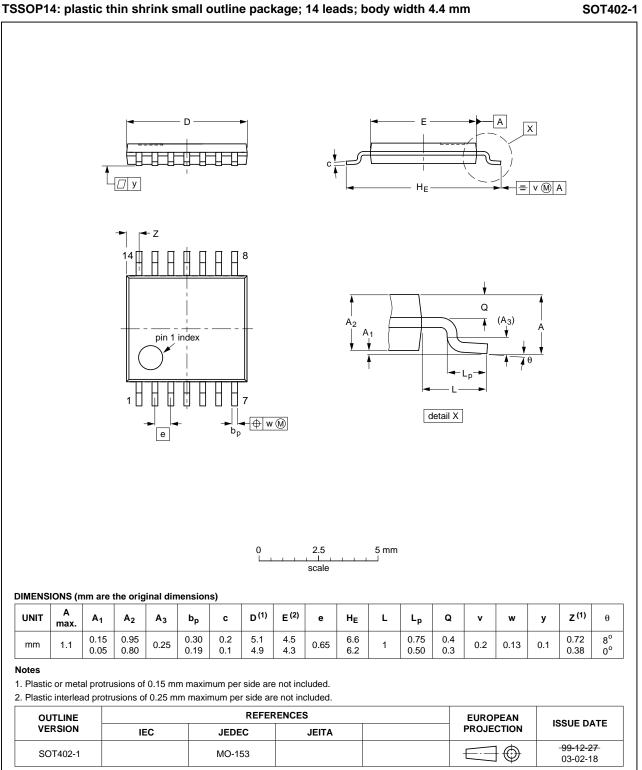
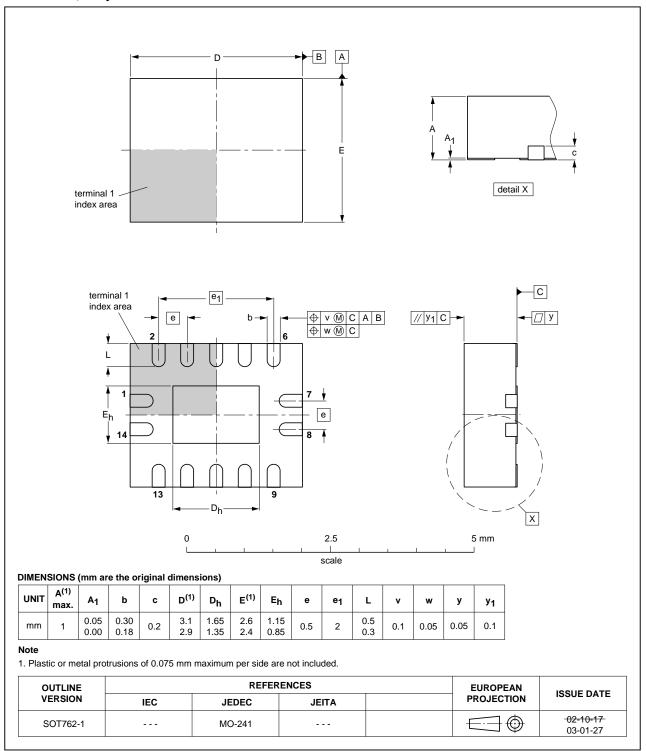


Fig 15. Package outline SOT402-1 (TSSOP14)

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DHVQFN14: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body 2.5 x 3 x 0.85 mm SOT762-1

Fig 16. Package outline SOT762-1 (DHVQFN14)

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14. Abbreviations

Table 9.	Abbreviations
Acronym	Description
CDM	Charged Device Model
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

15. Revision history

Table 10. Revision history							
Document ID	Release date	Data sheet status	Change notice	Supersedes			
74LVCU04 v.7	20111117	Product data sheet	-	74LVCU04A v.6			
Modifications:	 Legal pages upda 	ted.					
	• <u>Table 6</u> , bodyrow	∆I _{CC} : condition V _{CC} chan	ged.				
74LVCU04 v.6	20110809	Product data sheet	-	74LVCU04A v.5			
74LVCU04A v.5	20040312	Product specification	-	74LVCU04A v.4			
74LVCU04A v.4	20030901	Product specification	-	74LVCU04A v.3			
74LVCU04A v.3	19980729	Product specification	-	74LVCU04A v.2			
74LVCU04A v.2	19980729	Product specification	-	74LVCU04A v.1			
74LVCU04A v.1	19980729	Product specification	-	-			

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16. Legal information

16.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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